

Resonac Photonics Corporation

Marketing Department

Email: RPC_Elled@resonac.com

June 2023

DCP-260D

1. Material GaAlAs

2. Electrode P (anode) side : Au

N (cathode) side : Au

3. Electrode pattern Fig

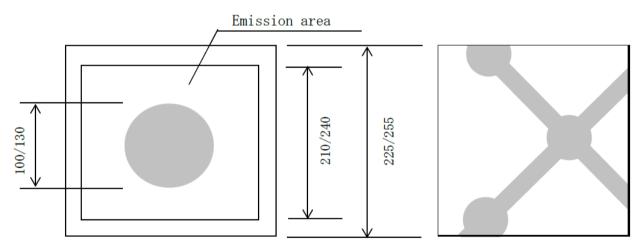
4. Chip size 0.240 mm × 0.240 mm × 0.190 mm (Fig.1)

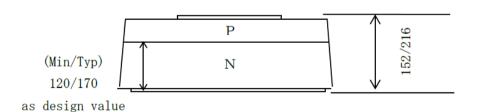
5. Emission area 0.225mm X 0.225mm (Fig.1)

6. Electro-Optical characteristics (Ta = 25°C)

Parameters	Symbol	Condition	Min	Тур	Max	Unit
Power	Po	IF=10mA	1.0	1.4	1.9	mW
Forward Voltage	VF	IF=10mA	-	1.45	1.60	V
Reverse Current	IR	VR=5V	-	-	10	uA
Peak Wavelength	λр	IF=20mA	•	850	-	nm
Spectral Radiation	Δλ(*)	IF=20mA	-	40	-	nm
Bandwidth						

- * (*) mark is reference data
- * Power Measurement at Resonac Photonics.
- 7. Recommended bonding method Ultra-sonic method or a combination of ultra-sonic and thermo-compression methods.





Backside Electrode pattern
This pattern is one example, and
different by each chip.

 $[\mu m]$

Fig: Chip size and Emission area and Electrode pattern

The information contained herein is believed to be reliable.

However, no representations, guaranties or warranties of any kind are made as to accuracy and suitability of the Product for particular applications or the results of its use.

Resonac Photonics Corporation reserves the right to introduce changes without notice.